DECLARATION FOR UTILITY PATENT APPLICATION (27.0 F.B. 1.62)		169.12-0502
		Richard L. Segar et al.
(3/ C.F.R. 1.63)	CO	MPLEȚE IF KNOWN
Declaration Submitted after Initial Filing (Surcharge (37 C.F.R. 1.16(e)) Required)	Application Number	
	Filing Date	Herewith
	Group Art Unit	
	Examiner Name	
•	Declaration Submitted after Initial Filing (Surcharge (37 C.F.R. 1.16(e))	APPLICATION First Named Inventor CO Declaration Submitted after Initial Filing (Surcharge (37 C.F.R. 1.16(e)) Required) First Named Inventor Application Number Filing Date Group Art Unit

As a below named inventor, I hereby declare that my residence, post office address, and citizenship are as stated below.

I believe I am the original, first and sole inventor (if only one name is listed below) or an original, first and joint inventor (if plural names are listed below) of the subject matter which is claimed and for which a patent is sought on the invention entitled: HGA BALLBOND ASSEMBLY WITH WAFER PROCESS ASSEMBLY FEATURES

the specification of which:			
$\underline{\mathbf{X}}$ is attached hereto OR			
was filed on as United applicable). I hereby state that I have amended by any amendment spec	States Application Number or P	CT International Application	Number and was amended on (if
applicable).			
I hereby state that I have	reviewed and understand the co	ntents of the above identified	d specification, including the claims, as
amended by any amendment spec	rifically referred to above.		
I acknowledge the duty to	o disclose information which is a	material to patentability as de	efined in 37 C.F.R. 1.56.
I hereby claim foreign profinventor's certificate, or 365(a) of States of America, listed below a certificate, or of any PCT internal	of any PCT international application and have also identified below, by	tion which designated at lease by checking the box, any fore	Foreign application(s) for patent or t one country other than the United eign application for patent or inventor's lication on which priority is claimed.
Prior Foreign Application Number(s)	Country	Foreign Filing Date (MM/DD/YYYY)	Certified Copy Attached? Yes No
I hereby claim the benefit	it under 35 U.S.C. 119(e) of any	United States provisional ap	oplication(s) listed below.
Application Number(s)		Filing Date (MM/DD/YYYY)	
60/249,081		11/15/2000	

I hereby claim the benefit under 35 U.S.C. 120 of any United States application(s), or 365(c) of any PCT international application designating the United States of America, listed below and, insofar as the subject matter of each of the claims of this application is not disclosed in the prior United States or PCT international application in the manner provided by the first paragraph of 35 U.S.C. 112, I acknowledge the duty to disclose information which is material to patentability as defined in 37 C.F.R. 1.56 which became available between the filing date of the prior application and the national or PCT international filing date of this application.

U.S. Parent Application or PCT Parent Number	Parent Filing Date (MM/DD/YYYY)	Parent Patent Number (if applicable)

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I hereby declare that all statements made herein of my own knowledge are true and that all statements made on information and belief are believed to be true; and further that these statements were made with the knowledge that willful false statements and the like so made are punishable by fine or imprisonment, or both, under 18 U.S.C. 1001 and that such willful false statements may jeopardize the validity of the application or any patent issued thereon.

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